



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer David W	Contact Title	Product Compliance Engineer for DND		
Company Unique ID	TE Connectivity	Response Date	2018-04-04	Contact Email	dave.benfer@te.com				
Contact Phone Number	717-986-3725								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	1734753-1	Amount	761.0	Version	-	Identity			
Manufacturer Item Name	MINI USB CONN, RCPT,V/T, B TYP	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions								
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	Shell Plating-Ni				1.0	0.3	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.2	1.0	6.0E-4	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.8	1.0	0.2994	mg	
Material	1	Shell Plating-Sn				1.0	0.3	mg	
Substance	2	Tin	Supplier	7440-31-5	99.9	1.0	0.2997	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.1	1.0	3.0E-4	mg	
Material	1	Contact Plating-Sn				1.0	0.3	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.1	1.0	3.0E-4	mg	
Substance	2	Tin	Supplier	7440-31-5	99.9	1.0	0.2997	mg	
Material	1	Shell-C5191				1.0	587.4	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.19	1.0	1.11606	mg	
Substance	2	Tin	Supplier	7440-31-5	6.25	1.0	36.7125	mg	
Substance	2	Copper	Supplier	7440-50-8	93.56	1.0	549.57144	mg	
Material	1	Contact Plating-Pd-Ni				1.0	0.3	mg	
Substance	2	Tin	Supplier	7440-31-5	20.0	1.0	0.06	mg	
Substance	2	Palladium	Supplier	7440-05-3	80.0	1.0	0.24	mg	
Material	1	Housing-PBT_Black				1.0	100.0	mg	
Substance	2	Antimony oxide (Sb2O3)	Supplier	1309-64-4	7.0	1.0	7.0	mg	
Substance	2	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	40.0	1.0	40.0	mg	

Substance	2	Phenol, 4,4-(1-methylethylidene)bis[2,6-dibromo-, polymer with 2,2-[(1-methylethylidene)bis(2,6-dibromo-4,1-phenylene)oxy methylene]]bis[oxirane]	Supplier	68928-70-1	20.0	1.0	20.0	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	30.0	mg	
Substance	2	Carbon black	Supplier	1333-86-4	3.0	1.0	3.0	mg	
Material	1	Contact Plating-Ni				1.0	0.3	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.2	1.0	6.0E-4	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.8	1.0	0.2994	mg	
Material	1	Contact Plating-Au				1.0	0.3	mg	
Substance	2	Gold	Supplier	7440-57-5	99.9	1.0	0.2997	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.1	1.0	3.0E-4	mg	
Material	1	Contact-C5191				1.0	71.8	mg	
Substance	2	Copper	Supplier	7440-50-8	93.56	1.0	67.17608	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.19	1.0	0.13642	mg	
Substance	2	Tin	Supplier	7440-31-5	6.25	1.0	4.4875	mg	